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SPECIFICATION

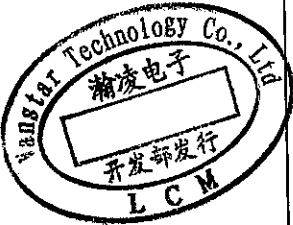
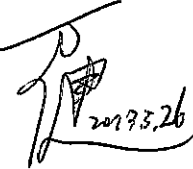
CUSTOMER :

MODULE NO.:

WF35LTIBCDATB#

未出样, 参数仅供参考

APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION: DATA:
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SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
		 2013.3.26	叶慧芬
ISSUED DATE: 2013-3-25			



DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2013.3.25		First issue

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1. Module Classification Information

W F 35 L T I B C D A T B #
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

①	Brand : WINSTAR DISPLAY CORPORATION						
②	Display Type : H→Character Type, G→Graphic Type F→TFT Type						
③	Display Size : 3.5 ” TFT						
④	Model serials no.						
⑤	Backlight Type :	F→CCFL, White			T→LED, White		
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction	I→Transmissive, W. T, 6:00 L→Transmissive, W.T,12:00					
⑦	A : TFT LCD B : TFT+FR+CONTROL BOARD C : TFT+FR+A/D BOARD D : TFT+FR+A/D BOARD+CONTROL BOARD E : TFT+FR+POWER BOARD F : TFT+CONTROL BOARD				G : TFT+FR H : TFT+D/V BOARD I : TFT+FR+D/V BOARD J : TFT+POWER BD		
⑧	Solution:						
	A: 128160	B:320234	C:320240	D:480234	E:480272	F: 640480	G: 800480
	H:1024600	I:320480	J:240320	K:800600	L:240400	M :1024768	
⑨	D: Digital L : LVDS						
⑩	Interface : N : without control board A : 8Bit B : 16Bit						
⑪	TS : N : Without TS T : resistive touch panel C : capacitive touch panel						
⑫	Version						
⑬	Special Code	#:Fit in with ROHS directive regulations					

2.Summary

This technical specification applies to 3.45' color TFT-LCD panel. The 3.45' color TFT-LCD panel is designed for camcorder, digital camera application and other electronic products which require high quality flat panel displays. This module follows RoHS.

3.General Specification

Item	Dimension	Unit
Dot Matrix	320 x RGBx240(TFT)	dots
Module dimension	93.5 x 66.44 x 6.76	mm
Active area	70.08 x 52.56	mm
Dot pitch	0.073 x 0.219	mm
LCD type	TFT, Negative, Transmissive	
View Direction	12 o'clock	
Gray Scale Inversion Direction	6 o'clock	
Backlight Type	LED, Normally White	
Controller IC	SSD1963	
Interface	Digital 8080 family MPU	

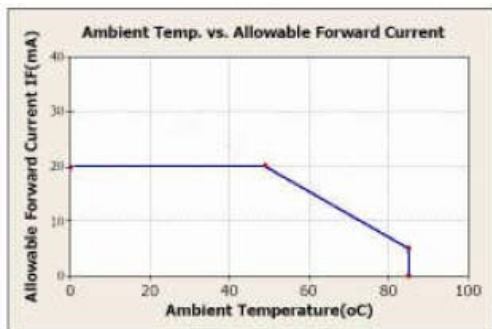
*Color tone slight changed by temperature and driving voltage.

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T _{OP}	-20	—	+70	°C
Storage Temperature	T _{ST}	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}\text{C}$, 90% RH MAX. Temp. $> 60^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 60°C



5. Electrical Characteristics

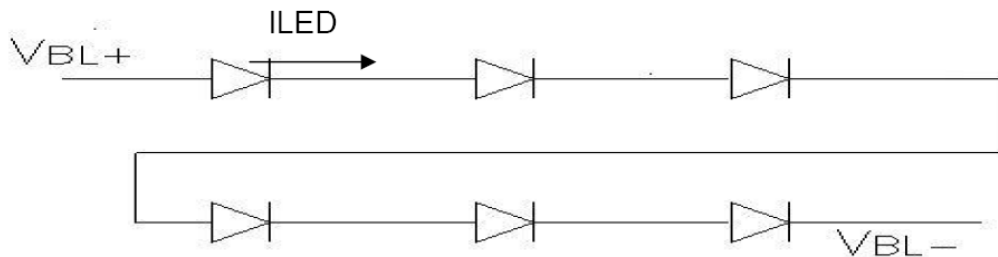
5.1. Operating conditions:

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	VDD	—	3.0	3.3	3.6	V

5.2 LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current		-	20	-	mA	
Power Consumption			384	408	mW	
LED voltage	VBL+	17.4	19.2	20.4	V	Note 1
LED Life Time		-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Note 2 : $T_a = 25\text{ }^{\circ}\text{C}$

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

6. DC Characteristics

Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3 VDD	V	
Hight level input voltage	V_{IH}	0.7 VDD	-	VDD	V	

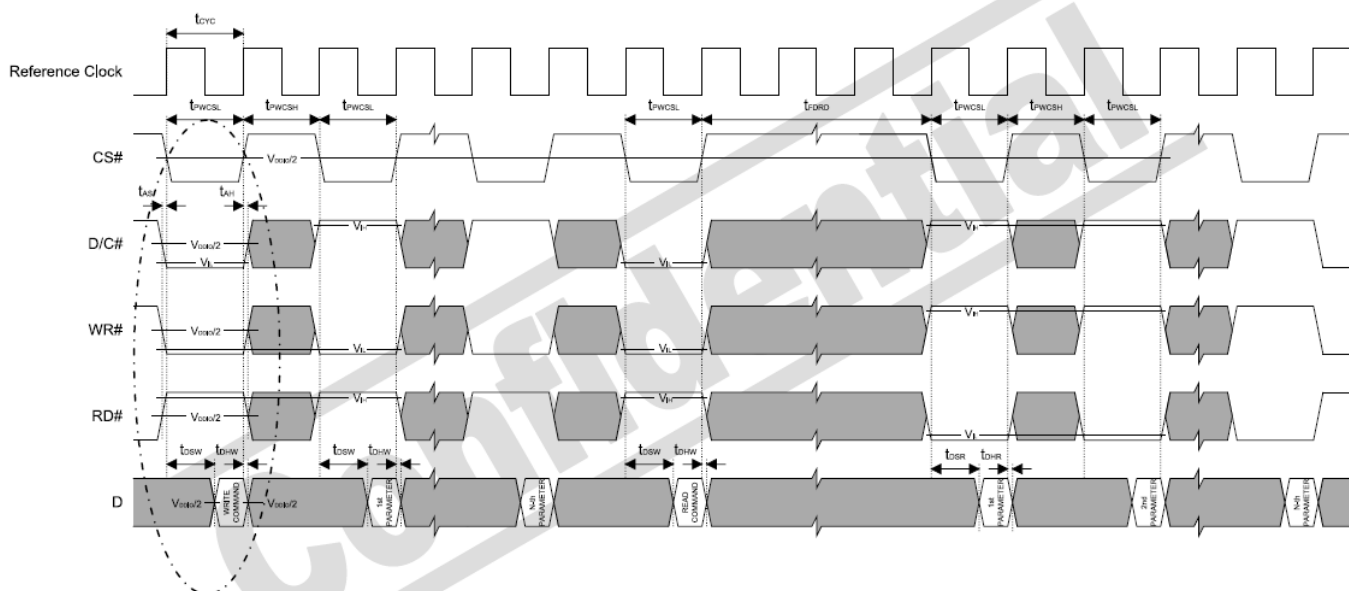
7. Interface Timing

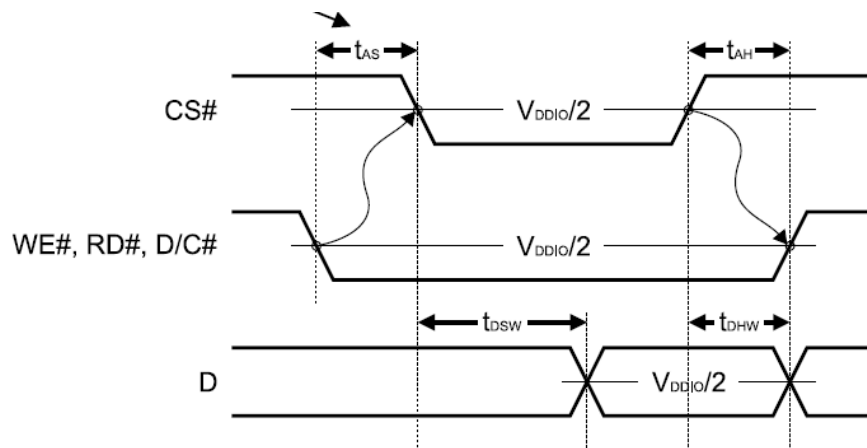
7.1.1 8080 Mode

The 8080 mode MCU interface consist of CS#, D/C#, RD#, WR#, D[23:0] and TE signals (Please refer to Table 6-1 for pin multiplexed with 6800 mode). This interface use WR# to define a write cycle and RD# for read cycle. If the WR# goes low when the CS# signal is low, the data or command will be latched into the system at the rising edge of WR#. Similarly, the read cycle will start when RD# goes low and end at the rising edge of RD#.

7.1.2 8080 Mode Write Cycle

Symbol	Parameter	Min	Typ	Max	Unit
t_{cyc}	Reference Clock Cycle Time	9	-	-	ns
t_{PWCSL}	Pulse width CS# low	1	-	-	t_{cyc}
t_{PWCSH}	Pulse width CS# high	1	-	-	t_{cyc}
t_{FDRD}	First Read Data Delay	5	-	-	t_{cyc}
t_{AS}	Address Setup Time	1	-	-	ns
t_{AH}	Address Hold Time	1	-	-	ns
t_{DSW}	Data Setup Time	4	-	-	ns
t_{DHW}	Data Hold Time	1	-	-	ns
t_{DSR}	Data Access Time	-	-	5	ns
t_{DHR}	Output Hold time	1	-	-	ns





7.1.3 Pixel Data Format

Interface	Cycle	D[23]	D[22]	D[21]	D[20]	D[19]	D[18]	D[17]	D[16]	D[15]	D[14]	D[13]	D[12]	D[11]	D[10]	D[9]	D[8]	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
24 bits	1 st	R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0
18 bits	1 st							R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
16 bits (565 format)	1 st									R5	R4	R3	R2	R1	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1
16 bits	1 st									R5	R4	R3	R2	R1	R0	X	X	G5	G4	G3	G2	G1	G0	X	X
	2 nd									B5	B4	B3	B2	B1	B0	X	X	R5	R4	R3	R2	R1	R0	X	X
	3 rd									G5	G4	G3	G2	G1	G0	X	X	B5	B4	B3	B2	B1	B0	X	X
9 bits	1 st																R5	R4	R3	R2	R1	R0	G5	G4	G3
	2 nd																G2	G1	G0	B5	B4	B3	B2	B1	B0
8 bits	1 st																	R5	R4	R3	R2	R1	R0	X	X
	2 nd																	G5	G4	G3	G2	G1	G0	X	X
	3 rd																	B5	B4	B3	B2	B1	B0	X	X

X: Don't Care

8. Optical Characteristic

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr	$\theta =0^{\circ}$ 、 $\Phi =0^{\circ}$	-	10		.ms	Note 3,5
		Tf		-	15		.ms	
Contrast ratio		CR	At optimized viewing angle	300	400	-	-	Note 4,5
Color Chromaticity	White	Wx	$\theta =0^{\circ}$ 、 $\Phi =0$	0.25	0.30	0.35		Note 2,6,7
		Wy		0.27	0.32	0.37		
Viewing angle	Hor.	$\ominus$ R	$CR \geq 10$	50	60		Deg.	Note 1
		$\ominus$ L		50	60			
	Ver.	Φ T		40	50			
		Φ B		45	55			
Brightness		-	-	240	-	350	cd/m	Center of display

Ta=25±2°C, IL=20mA

Note 1: Definition of viewing angle range

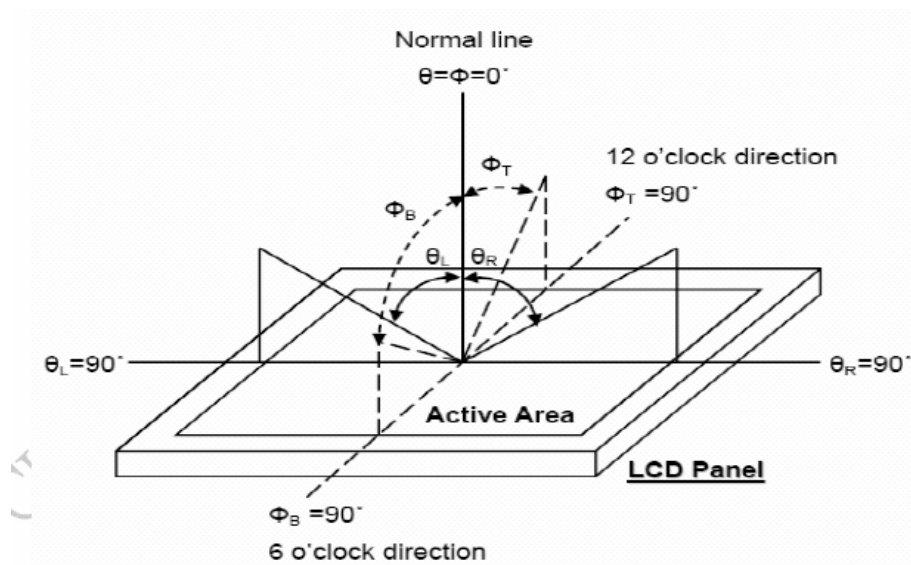


Fig. 8-1 Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

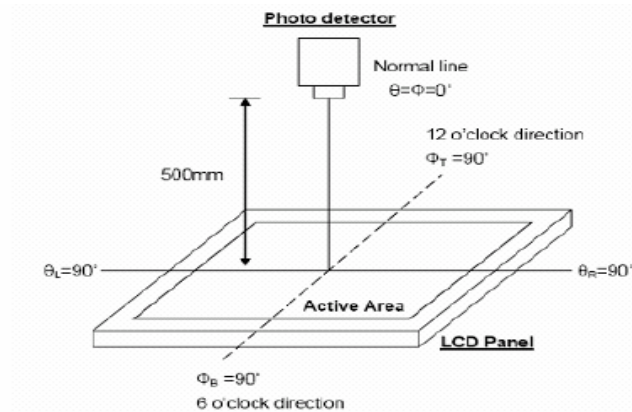


Fig. 8-2 Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between “White” state and “Black” state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%.

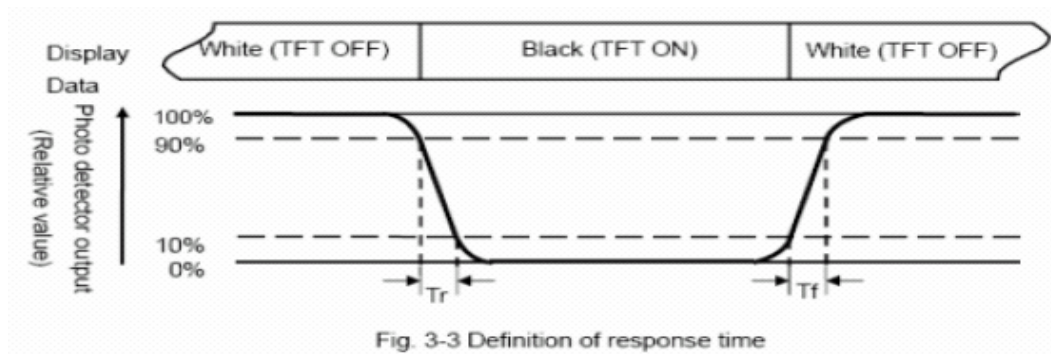


Fig. 3-3 Definition of response time

Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White $V_i = V_{i50} \pm 1.5V$

Black $V_i = V_{i50} \pm 2.0V$

“±” means that the analog input signal swings in phase with VCOM signal.

“±” means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

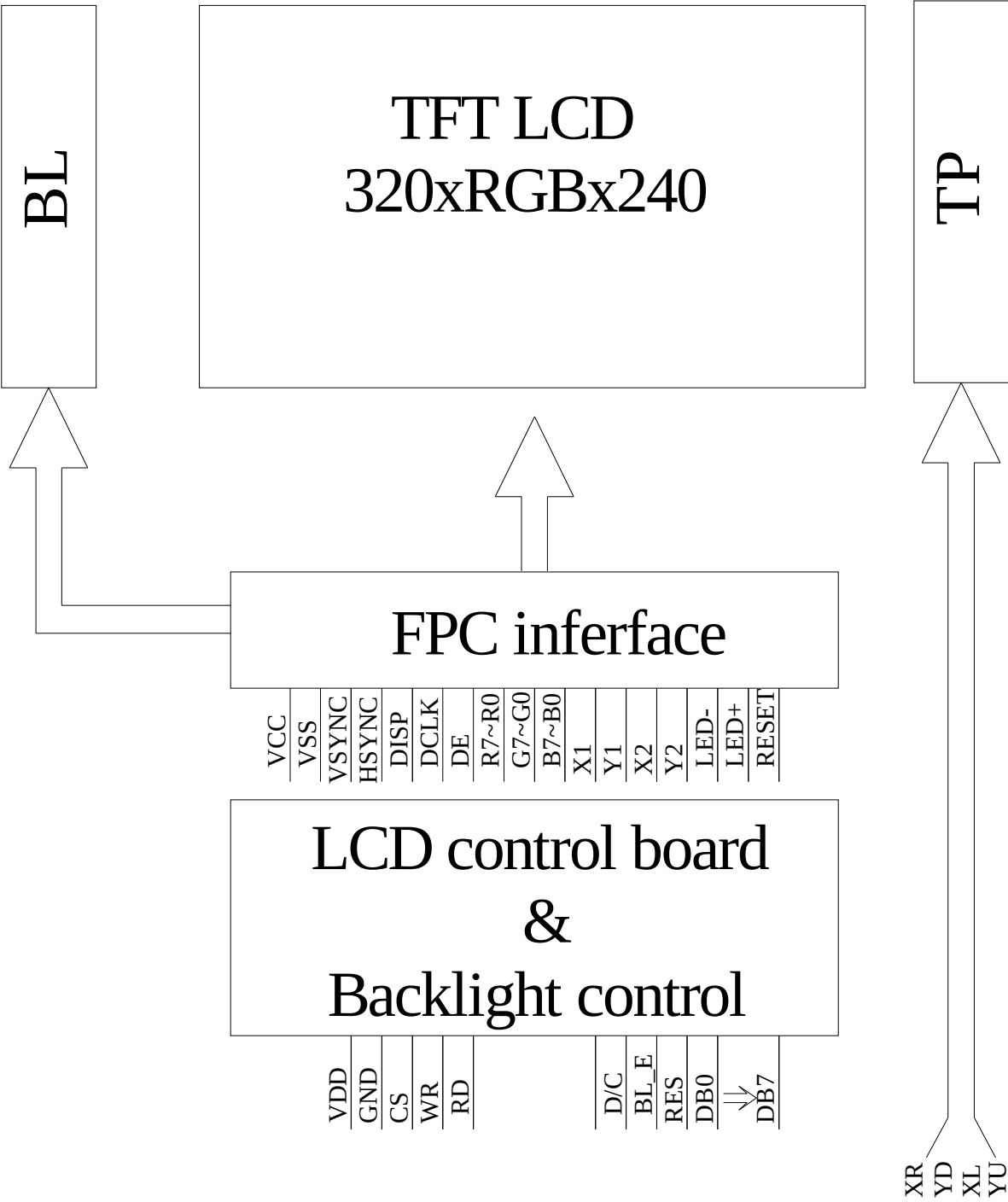
$$\text{Note 8 : Uniformity (U)} = \frac{\text{Brightness (min)}}{\text{Brightness (max)}} \times 100\%$$

9. Interface

9.1. LCM PIN Definition

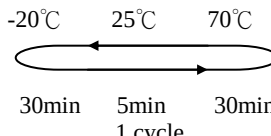
Pin	Symbol	I/O	Function	Remark
1	GND	P	System ground pin of the IC. Connect to system ground.	
2	VDD	P	Power Supply : +3.3V	
3	BL_E	I	Backlight control signal , H: On \ L:Off	
4	D/C	I	Data/Command select	
5	WR	I	Write strobe signal	
6	RD	I	Read strobe signal	
7	DB0	I	Data bus	
8	DB1	I	Data bus	
9	DB2	I	Data bus	
10	DB3	I	Data bus	
11	DB4	I	Data bus	
12	DB5	I	Data bus	
13	DB6	I	Data bus	
14	DB7	I	Data bus	
15	CS	I	Chip select	
16	RES	I	Hardware reset	
17	NC	-	No connect	
18	NC	-	No connect	
19	NC	-	No connect	
20	NC	-	No connect	

10. Block Diagram



11. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

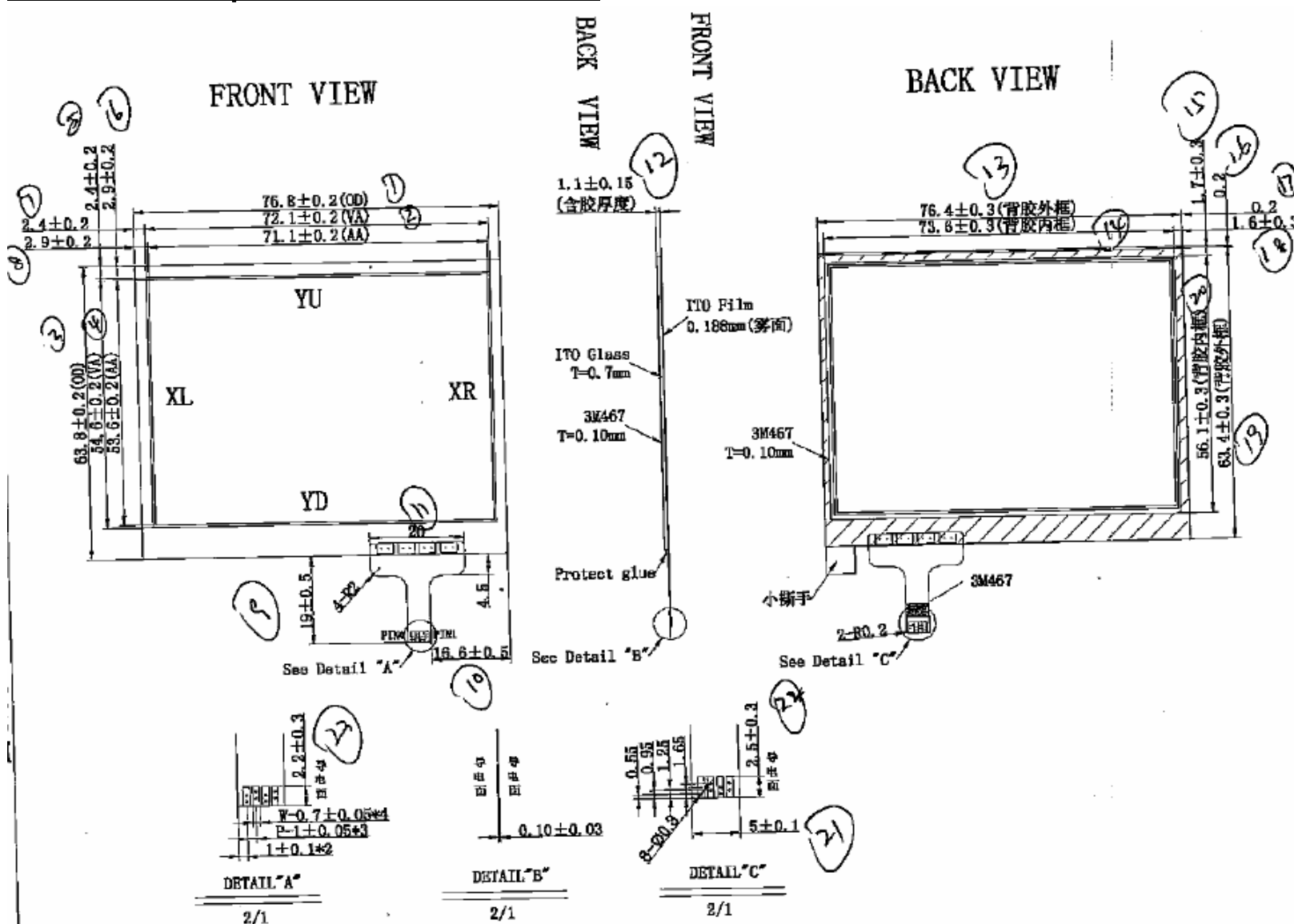
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 3 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	—

Note1: No dew condensation to be observed.

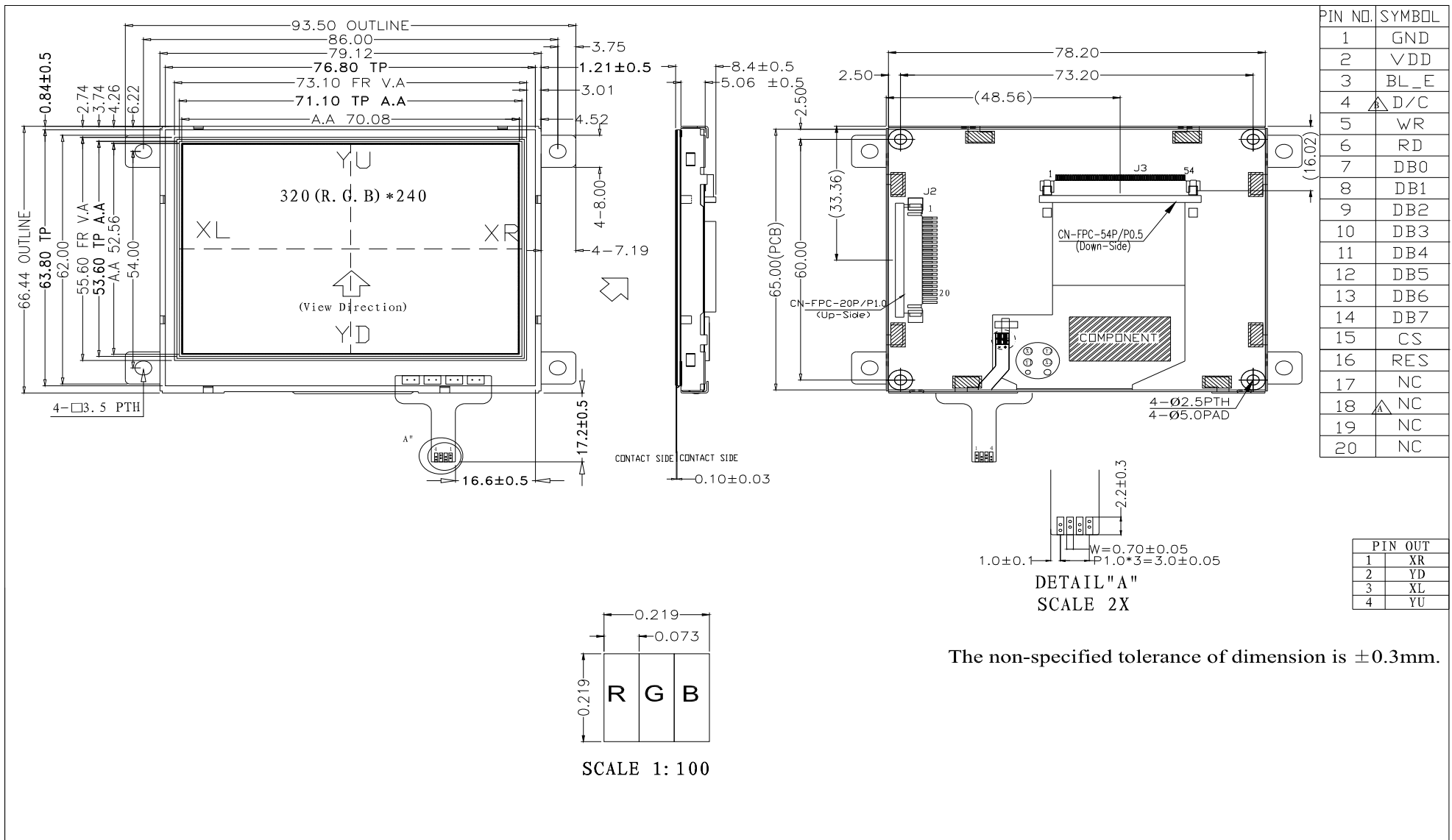
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

12. Touch panel Information



13. Contour Drawing



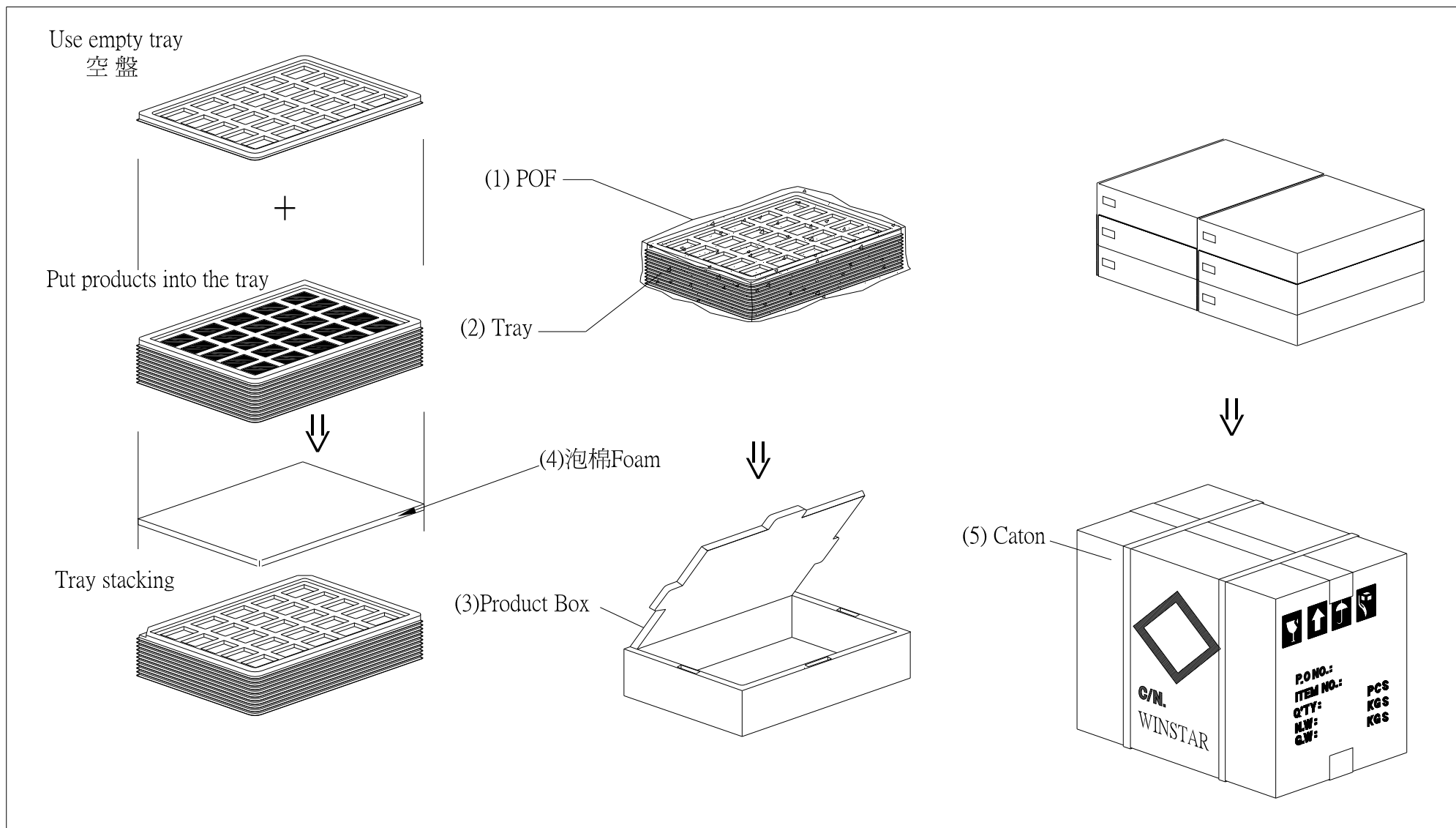
14. PACKAGE SPECIFICATION

LCM Model WF35LTIBCDATB#		LCM 包裝規格書 LCM Packaging Specifications		Approve	Check	Contact
Drawing NO.				DATE	初版	版次 Ver
				12'11/15	12'11/15	0

1.包裝材料規格表（Packaging Material）:(per carton)				
NO.	Item	Model	Dimensions	Quantity
1	成品（LCM）	WF35LTIBCDATB#	TBD	TBD
2	TRAY 盤 (2)	TBD	TBD	TBD
3	BP01 內盒(3)Product Box	PK3R1XXXXXXXXXXXX0001	TBD	TBD
4	泡棉(4)Foam	-----	283 x 230 x 8	TBD
5	外紙箱(5)Carton	PK4Q1XXXXXXXXXXXX0000	565 x 340 x 320	TBD
6				
7				
8				
9				

2.單箱數量規格表(Packaging Specifications and Quantity) :			
(1)LCM quantity per box : no per tray	TBD	x no of tray	TBD = TBD
(2)Total LCM quantity in carton : quantity per box	TBD	x no of boxes	TBD = TBD

特 記 事 項 (REMARK)		
1. Label Specifications : MOOEL: LOT NO : QUANTITY: CHECK:		



15. Initial Code For Reference

TBD



Module Number : _____

Page: 1

1、Panel Specification :

- | | | |
|----------------------------|-------------------------------|-------------------------------------|
| 1. Panel Type : | ☐ Pass | ☐ NG , _____ |
| 2. View Direction : | ☐ Pass | ☐ NG , _____ |
| 3. Numbers of Dots : | ☐ Pass | ☐ NG , _____ |
| 4. View Area : | ☐ Pass | ☐ NG , _____ |
| 5. Active Area : | ☐ Pass | ☐ NG , _____ |
| 6. Operating Temperature : | ☐ Pass | ☐ NG , _____ |
| 7. Storage Temperature : | ☐ Pass | ☐ NG , _____ |
| 8. Others : | _____ | |

2、Mechanical Specification :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. PCB Size : | ☐ Pass | ☐ NG , _____ |
| 2. Frame Size : | ☐ Pass | ☐ NG , _____ |
| 3. Material of Frame : | ☐ Pass | ☐ NG , _____ |
| 4. Connector Position : | ☐ Pass | ☐ NG , _____ |
| 5. Fix Hole Position : | ☐ Pass | ☐ NG , _____ |
| 6. Backlight Position : | ☐ Pass | ☐ NG , _____ |
| 7. Thickness of PCB : | ☐ Pass | ☐ NG , _____ |
| 8. Height of Frame to PCB : | ☐ Pass | ☐ NG , _____ |
| 9. Height of Module : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

3、Relative Hole Size :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. Pitch of Connector : | ☐ Pass | ☐ NG , _____ |
| 2. Hole size of Connector : | ☐ Pass | ☐ NG , _____ |
| 3. Mounting Hole size : | ☐ Pass | ☐ NG , _____ |
| 4. Mounting Hole Type : | ☐ Pass | ☐ NG , _____ |
| 5. Others : | ☐ Pass | ☐ NG , _____ |

4、Backlight Specification :

- | | | |
|---|-------------------------------|-------------------------------------|
| 1. B/L Type : | ☐ Pass | ☐ NG , _____ |
| 2. B/L Color : | ☐ Pass | ☐ NG , _____ |
| 3. B/L Driving Voltage (Reference for LED Type) : | ☐ Pass | ☐ NG , _____ |
| 4. B/L Driving Current : | ☐ Pass | ☐ NG , _____ |
| 5. Brightness of B/L : | ☐ Pass | ☐ NG , _____ |
| 6. B/L Solder Method : | ☐ Pass | ☐ NG , _____ |
| 7. Others : | ☐ Pass | ☐ NG , _____ |

>> Go to page 2 <<

Module Number : _____

Page: 2

5、Electronic Characteristics of Module :

- | | | |
|------------------------------|-------------------------------|-------------------------------------|
| 1. Input Voltage : | ☐ Pass | ☐ NG , _____ |
| 2. Supply Current : | ☐ Pass | ☐ NG , _____ |
| 3. Driving Voltage for LCD : | ☐ Pass | ☐ NG , _____ |
| 4. Contrast for LCD : | ☐ Pass | ☐ NG , _____ |
| 5. B/L Driving Method : | ☐ Pass | ☐ NG , _____ |
| 6. Negative Voltage Output : | ☐ Pass | ☐ NG , _____ |
| 7. Interface Function : | ☐ Pass | ☐ NG , _____ |
| 8. LCD Uniformity : | ☐ Pass | ☐ NG , _____ |
| 9. ESD test : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

6、Summary :

Sales signature : _____

Customer Signature : _____

Date : ____ / ____ / ____